



60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C		
00)/	$12m\Omega$ @ $V_{GS} = 10V$	9.8A		
60V	$14m\Omega @ V_{GS} = 4.5V$	8.4A		

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- High Conversion Efficiency
- Low R_{DS(ON)} Ensures On-State Losses Are Minimized
- Excellent Q_{GD} x R_{DS(ON)} Product (FOM)
- Advanced Technology for DC-DC Converters
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

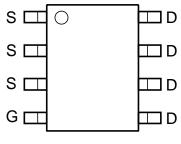
- Power Management Functions
- DC-DC Converters
- Backlighting

Mechanical Data

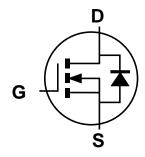
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)







Top View Internal Schematic



Equivalent Circuit

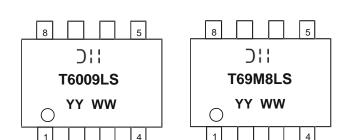
Ordering Information (Note 4)

Part Number	Case	Packaging
DMT69M8LSS-13	SO-8	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



);;= Manufacturer's Marking T6009LS & T69M8LS = Date Code Marking YY or \(\overline{YY} = \text{Year (ex: 17 = 2017)} \) WW = Week (01 to 53)



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	60	V		
Gate-Source Voltage	V _{GSS}	±16	V		
Continuous Dusis Comment (Nata C) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	9.8 7.9	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	12.2 9.5	А
Maximum Continuous Body Diode Forward Curre	I _S	3	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	60	Α		
Avalanche Current, L = 0.1mH	I _{AS}	25	А		
Avalanche Energy, L = 0.1mH	E _{AS}	31.5	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	1.25	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	100	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s		55.5	°C/W
Total Power Dissipation (Note 6)		P_D	1.6	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	75	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	42	°C/W
Thermal Resistance, Junction to Case (Note 6)		R ₀ JC	12	°C/W
Operating and Storage Temperature Range		$T_{J_1}T_{STG}$	-55 to +150	°C

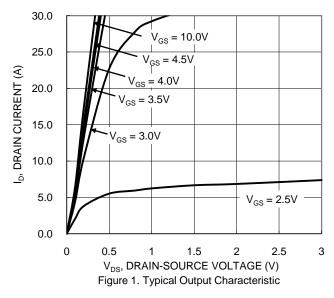
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

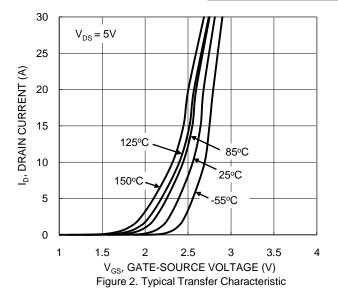
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60		_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.7	_	2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	_	_	9.8	12	mΩ	$V_{GS} = 10V, I_D = 13.5A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	12	14		$V_{GS} = 4.5V, I_D = 11.5A$	
Diode Forward Voltage	V _{SD}	_	0.9	1.2	V	$V_{GS} = 0V, I_S = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	1,925	_		$V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$	
Output Capacitance	Coss	_	438	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	41	_			
Gate Resistance	R_{G}	_	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Q_G	_	33.5	_			
Total Gate Charge (V _{GS} = 4.5V)	Q_{G}	_	15.6	_	nC	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
Gate-Source Charge	Q _{GS}	_	4.7	_	nc	$V_{DS} = 30V, I_{D} = 13.5A$	
Gate-Drain Charge	Q_{GD}	_	5.3	_			
Turn-On Delay Time	t _{D(ON)}	_	4.5	_		$V_{DD} = 30V, V_{GS} = 10V,$ $R_G = 6\Omega, I_D = 13.5A$	
Turn-On Rise Time	t _R	_	8.6	_			
Turn-Off Delay Time	t _{D(OFF)}	_	35.9	_	ns		
Turn-Off Fall Time	t _F	_	15.7	_			
Body Diode Reverse Recovery Time	t _{RR}	_	18.2	_	ns	1 42.54 4:/44 4004/	
Body Diode Reverse Recovery Charge	Q_{RR}	_	33.1	_	nC	$I_F = 13.5A$, di/dt = 400A/ μ s	

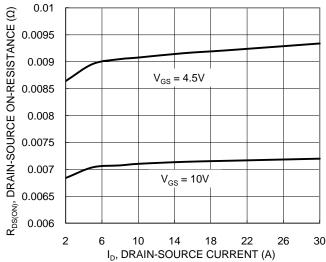
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:











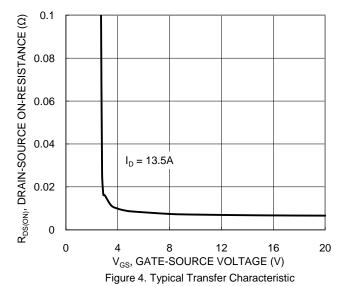
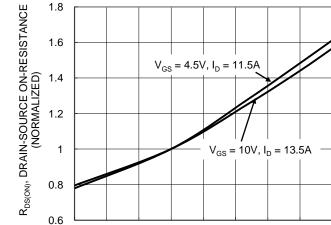
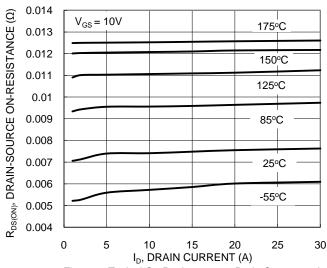


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage



25



 T_J , JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Junction Temperature

50

75

100

Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

-50





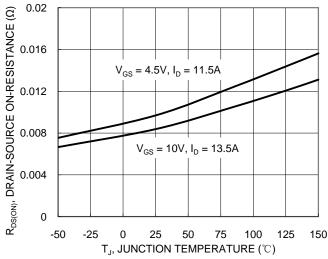


Figure 7. On-Resistance Variation with Junction Temperature

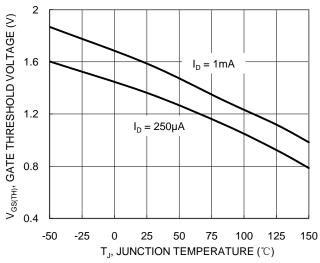


Figure 8. Gate Threshold Variation vs. Junction Temperature

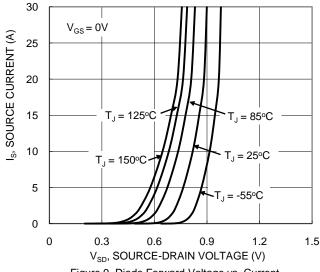


Figure 9. Diode Forward Voltage vs. Current

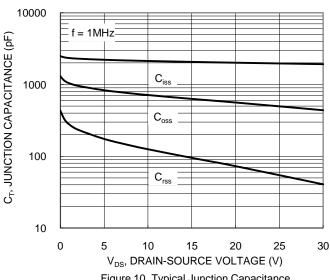
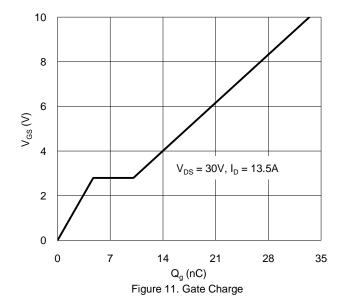
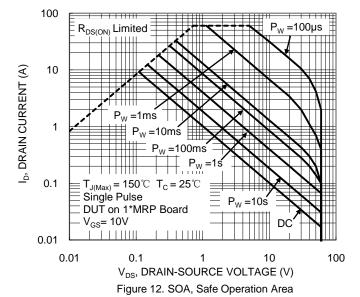


Figure 10. Typical Junction Capacitance







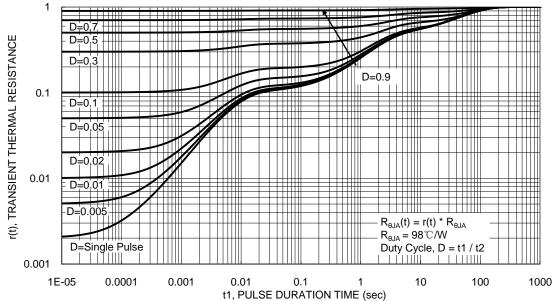


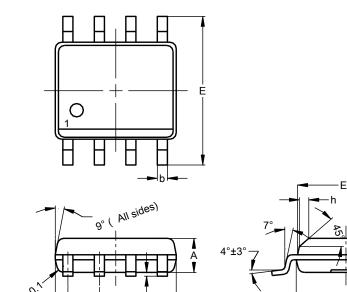
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



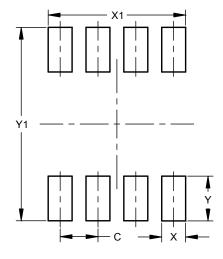
SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A 1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
С	0.15	0.25	0.20			
D	4.85	4.95	4.90			
Е	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е	-	-	1.27			
h	ı	-	0.35			
L	0.62	0.82	0.72			
Q	0.60	0.70	0.65			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8

-Gauge Plane Seating Plane



Dimensions	Value (in mm)				
С	1.27				
Х	0.802				
X1	4.612				
Y	1.505				
Y1	6.50				



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